N THE CHAPED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Norio FUKASAWA et al.

Serial No.: **09/766,656**

Filed: January 23, 2001

January 23, 2001

METHOD AND MOLD FOR MANUFACTURING SEMICONDUCTOR DEVICE,

SEMICONDUCTOR DEVICE, AND METHOD FOR MOUNTING THE DEVICE

INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 CFR 1.97(b)

Commissioner for Patents Washington, D.C. 20231

February 21, 2002

Group Art Unit:

Examiner: To be assigned

Sir:

For:

The attention of the Patent and Trademark Office is hereby directed to the document listed on the attached Form PTO-1449. One copy of this document is attached.

No fee or certification is required in connection with this Information Disclosure Statement, since it is being submitted prior to the issuance of a first official action on the merits or expiration of the three month period following the filing date or the entry of the national stage of the above-captioned application.

The above information is presented so that the Patent and Trademark Office can, in the first instance, determine any materiality thereof to the claimed invention. See 37 CFR 1.104(a) concerning the PTO duty to consider and use any such information. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the documents cited in the attached Form PTO-1449 be made of record therein and appear on the first page of any patent to issue therefrom.

IDS RAMOG IBILIOZ

The Commissioner is authorized to charge our Deposit Account No. 01-2340 for any fee which is deemed by the Patent and Trademark Office to be required to effect consideration of this statement.

Respectfully submitted,

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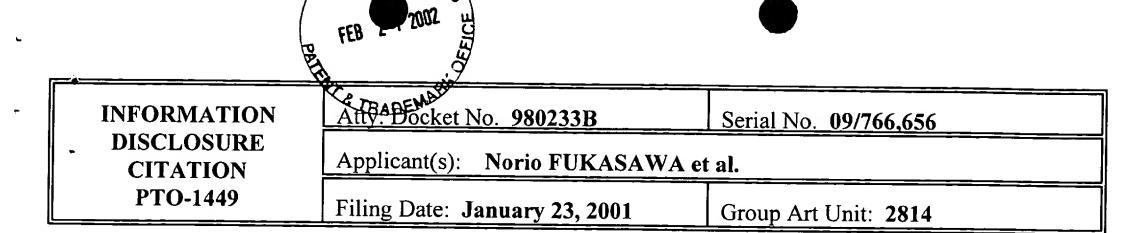
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Enclosures: PTO-1449 and <u>1</u> reference



U.S. PATENT DOCUMENTS

Examiner Initial		Document No.	Name	Date	Class	Subclass	Filing Date (If appropriate)
	AA						
	AB						
	AC						
	AD						
	AE						

FOREIGN PATENT DOCUMENTS

		Document No.	Date	Country	Translation (Yes or No)
	AF				
	AG				
<u> </u>	AH				
h	AI				
	AJ				

OTHER DOCUMENTS

	AK	Full translation of Japanese Patent Application 08-064725
	AL	
Examiner		Date Considered